

For immediate release

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## **NEXX Systems Announces Opening of Singapore Office**

**Billerica, MA – September 12, 2006** – NEXX Systems, a leading provider of processing equipment for advanced wafer-level packaging applications, today announced that it has named Kenneth Ramsey as Vice President of Asia Operations. Mr. Ramsey will head the Singapore office, opening in September 2006.

Stated Richard Post, CEO, "We are delighted to announce this strengthening of our sales organization to better serve both our current customers, as well as to enhance our opportunities in the wafer level packaging marketplace. Ken Ramsey, with his expertise in both the industry and the region, is ideally suited to lead NEXX's growing presence in Asia. The Singapore office will enable us to work even more closely with our significant customer base in the region."

Mr. Ramsey added, "As an industry participant, I have watched NEXX enter and rapidly grow in the bumped wafer process equipment market. NEXX tools address one of the fastest growing segments of the semiconductor market, and I look forward to working with the team to help bring their advanced solutions to the Asian customer base. It is exciting to be associated with such an industry-leading company."

Mr. Ramsey comes to NEXX with more than 20 years experience in positions dealing with the definition, development, and implementation of sales and marketing strategies for technical hardware products, software, and systems. Most recently, he was vice president of Southeast Asia sales and managing director of Amkor's Singapore sales office. He brings to NEXX a wealth of experience in the semiconductor industry and with NEXX's customer base, as well as more than 13 years living in Singapore.

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About NEXX Systems: NEXX Systems brings exceptional technical expertise to flip chip and advanced packaging. Our product lines provide the most efficient, yet affordable, systems of their kind: Nimbus for multi-layer sputter deposition of metals, and Stratus for high throughput electro-deposition of metals. Additional information can be found at: [www.nexxsystems.com](http://www.nexxsystems.com).

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